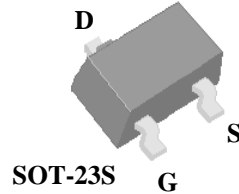
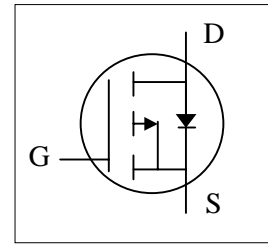




- ▼ Capable of 2.5V Gate Drive
- ▼ Small Package Outline
- ▼ Surface Mount Device
- ▼ RoHS Compliant & Halogen-Free



$BV_{DSS}$	-20V
$R_{DS(ON)}$	65m $\Omega$
$I_D$	- 3.7A



**Description**

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The SOT-23S package is widely preferred for commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

**Absolute Maximum Ratings @ $T_j=25^\circ\text{C}$  (unless otherwise specified)**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	- 20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D @ T_A=25^\circ\text{C}$	Drain Current <sup>3</sup> , $V_{GS}$ @ 4.5V	-3.7	A
$I_D @ T_A=70^\circ\text{C}$	Drain Current <sup>3</sup> , $V_{GS}$ @ 4.5V	-3	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	-10	A
$P_D @ T_A=25^\circ\text{C}$	Total Power Dissipation	1.25	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

**Thermal Data**

Symbol	Parameter	Value	Unit
$R_{thj-amb}$	Maximum Thermal Resistance, Junction-ambient <sup>3</sup>	100	$^\circ\text{C}/\text{W}$



# AP2305GN

## Electrical Characteristics @T<sub>j</sub>=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=-10V, I_D=-4.5A$	-	38	53	mΩ
		$V_{GS}=-4.5V, I_D=-4.2A$	-	40	65	mΩ
		$V_{GS}=-2.5V, I_D=-2.0A$	-	60	100	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.5	-	-1.16	V
$g_{fs}$	Forward Transconductance	$V_{DS}=-5V, I_D=-4A$	-	14	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=-20V, V_{GS}=0V$	-	-	-1	μA
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	±100	nA
$Q_g$	Total Gate Charge	$I_D=-4A$	-	13	21	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=-16V$	-	1.4	-	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=-4.5V$	-	4	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=-10V$	-	8	-	ns
$t_r$	Rise Time	$I_D=-1A$	-	17	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega$	-	24	-	ns
$t_f$	Fall Time	$V_{GS}=-5V$	-	33	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	920	1470	pF
$C_{oss}$	Output Capacitance	$V_{DS}=-20V$	-	90	-	pF
$C_{rss}$	Reverse Transfer Capacitance	$f=1.0MHz$	-	85	-	pF
$R_g$	Gate Resistance	$f=1.0MHz$	-	4.5	9	Ω

## Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>2</sup>	$I_S=-1.2A, V_{GS}=0V$	-	-	-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_S=-4A, V_{GS}=0V,$	-	27	-	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	14	-	nC

### Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board,  $t \leq 10s$  ; 300°C/W when mounted on min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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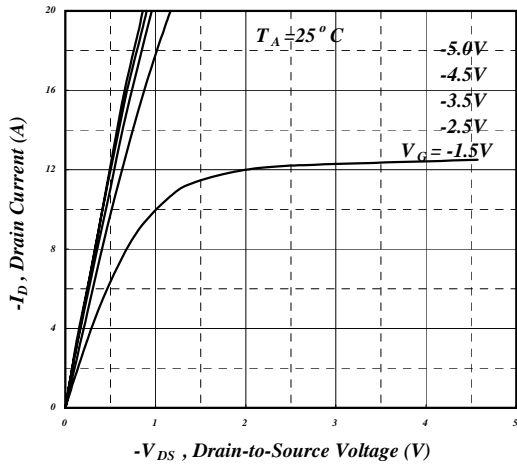


Fig 1. Typical Output Characteristics

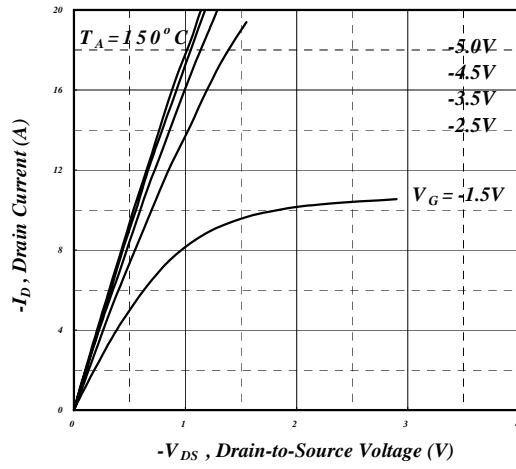


Fig 2. Typical Output Characteristics

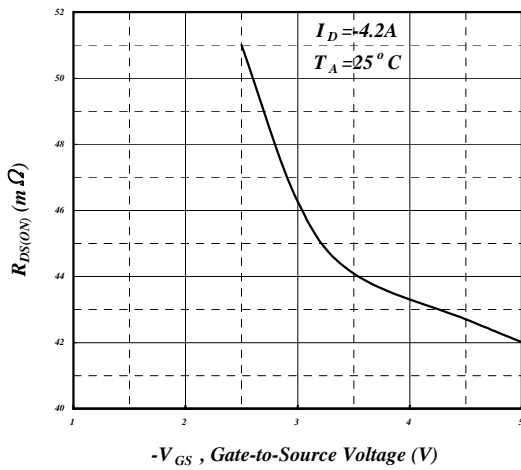


Fig 3. On-Resistance v.s. Gate Voltage

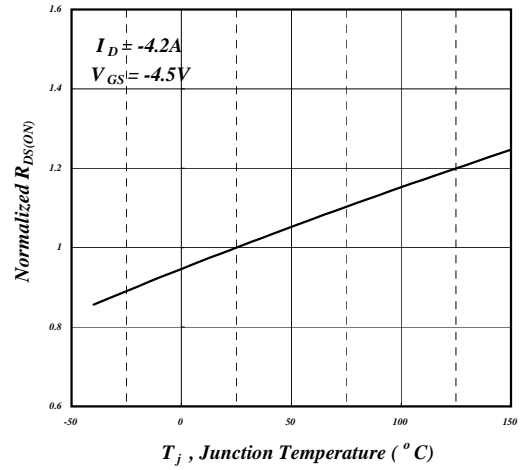


Fig 4. Normalized On-Resistance v.s. Junction Temperature

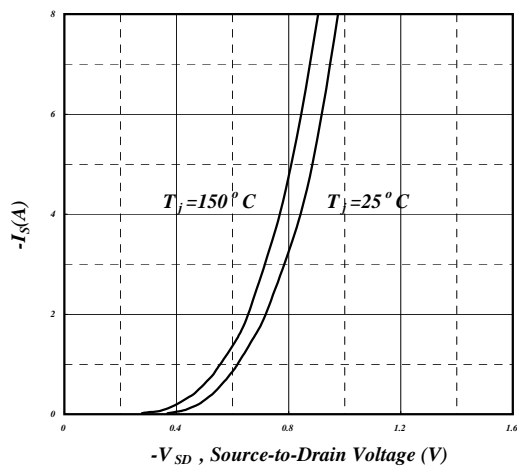


Fig 5. Forward Characteristic of Reverse Diode

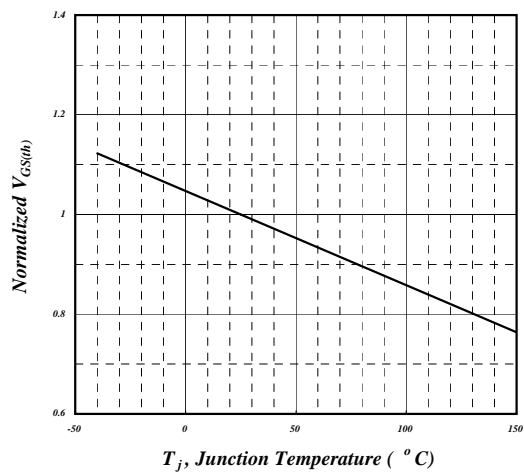


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

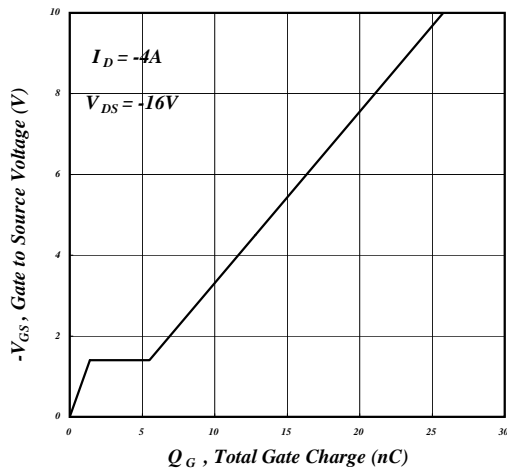


Fig 7. Gate Charge Characteristics

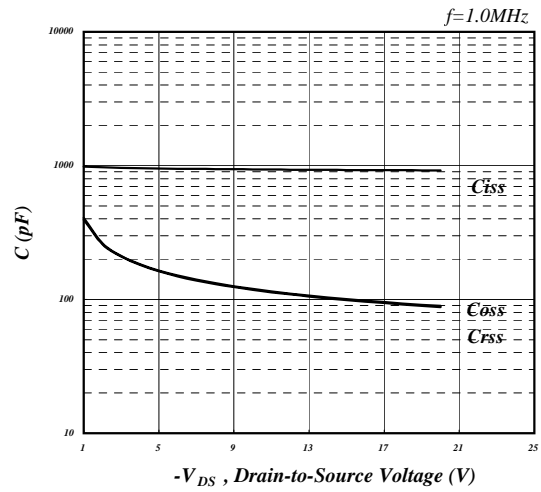


Fig 8. Typical Capacitance Characteristics

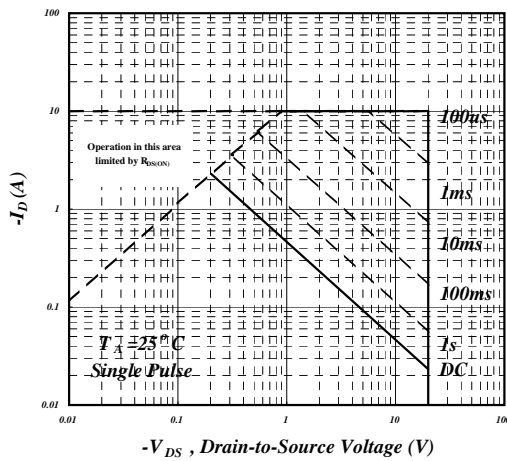


Fig 9. Maximum Safe Operating Area

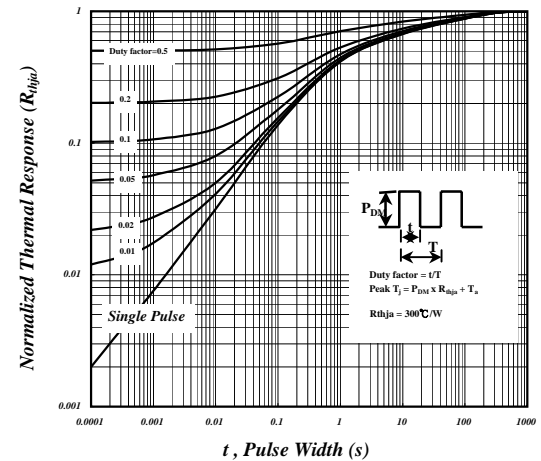


Fig 10. Effective Transient Thermal Impedance

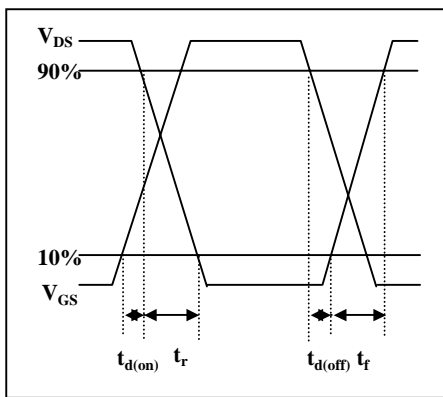


Fig 11. Switching Time Waveform

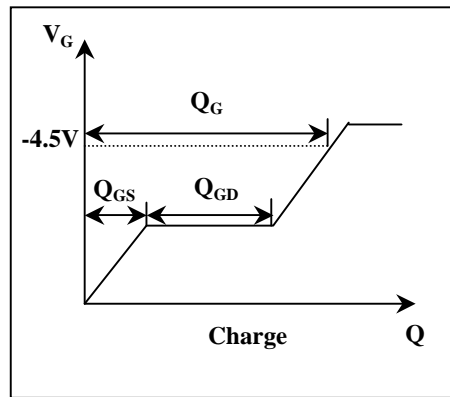
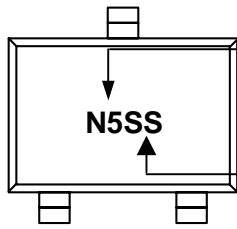


Fig 12. Gate Charge Waveform



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**MARKING INFORMATION**



Part Number : N5

Date Code : SS

SS:2004,2008,2012...

SS:2003,2007,2011...

SS:2002,2006,2010...

SS:2001,2005,2009...

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